

P-Channel 1.8 V (G-S) MOSFET

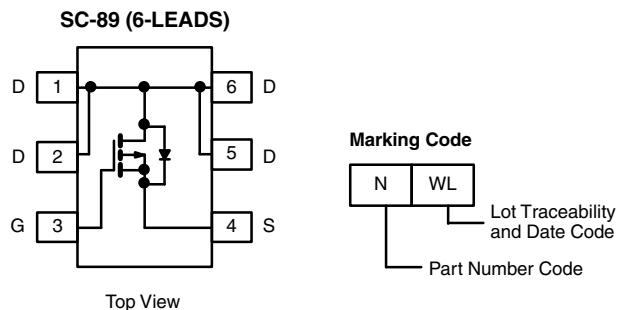
PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
- 20	0.195 at $V_{GS} = - 4.5$ V	- 0.84
	0.260 at $V_{GS} = - 2.5$ V	- 0.73
	0.350 at $V_{GS} = - 1.8$ V	- 0.64

FEATURES

- Halogen-free According to IEC 61249-2-21
- Definition
- TrenchFET® Power MOSFET
- Low Threshold
- Smallest LITTLE FOOT® Package: 1.6 mm x 1.6 mm
- Low 0.6 mm Profile
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE



Ordering Information: Si1037X-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- Cell Phones and Pagers
- - Load Switch
- Battery Operated Systems

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)					
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V_{GS}			
Continuous Drain Current ($T_J = 150$ °C) ^a		I_D	- 0.84	- 0.77	A
			- 0.68	- 0.62	
Pulsed Drain Current		I_{DM}	- 4		
Continuous Diode Current (Diode Conduction) ^a		I_S	- 0.18	- 0.14	
Maximum Power Dissipation ^a		P_D	0.21	0.17	W
			0.13	0.10	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 5$ s	R_{thJA}	500	600	°C/W
	Steady State		600	720	

Notes:

a. Surface mounted on 1" x 1" FR4 board with minimum copper.

SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)

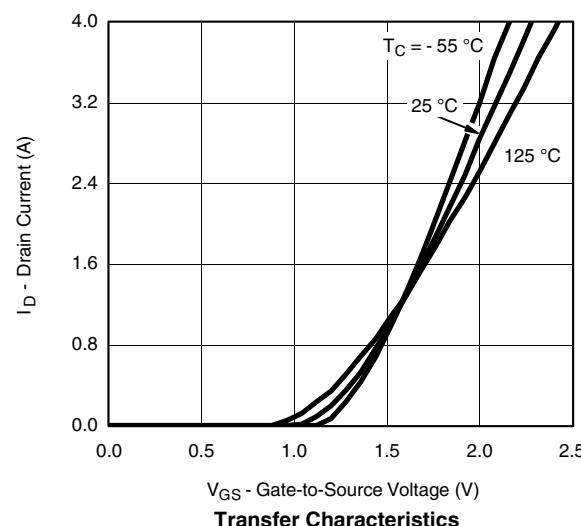
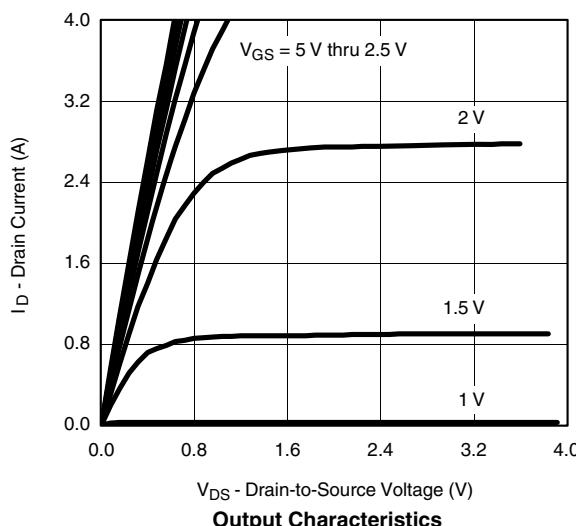
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = -250\ \mu\text{A}$	- 0.45			V
Gate-Body Leakage	I_{GS}	$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 8\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DS}	$V_{DS} = -20\ \text{V}$, $V_{GS} = 0\ \text{V}$			- 1	μA
		$V_{DS} = -20\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 70^\circ\text{C}$			- 5	
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{DS} = -5\ \text{V}$, $V_{GS} = -4.5\ \text{V}$	- 4			A
Drain-Source On-State Resistance ^a	$R_{DS(\text{on})}$	$V_{GS} = -4.5\ \text{V}$, $I_D = -0.77\ \text{A}$		0.160	0.195	Ω
		$V_{GS} = -2.5\ \text{V}$, $I_D = -0.67\ \text{A}$		0.212	0.260	
		$V_{GS} = -1.8\ \text{V}$, $I_D = -0.2\ \text{A}$		0.290	0.350	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -10\ \text{V}$, $I_D = -0.77\ \text{A}$		3.1		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -0.14\ \text{A}$, $V_{GS} = 0\ \text{V}$		- 0.78	- 1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -10\ \text{V}$, $V_{GS} = -4.5\ \text{V}$, $I_D = -0.77\ \text{A}$		3.5	5.5	nC
Gate-Source Charge	Q_{gs}			0.65		
Gate-Drain Charge	Q_{gd}			0.60		
Turn-On Delay Time	$t_{d(\text{on})}$	$V_{DD} = -10\ \text{V}$, $R_L = 20\ \Omega$ $I_D \geq -0.5\ \text{A}$, $V_{GEN} = -4.5\ \text{V}$, $R_G = 6\ \Omega$		10	20	ns
Rise Time	t_r			15	30	
Turn-Off Delay Time	$t_{d(\text{off})}$			30	60	
Fall Time	t_f			10	20	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -0.14\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$		20	40	

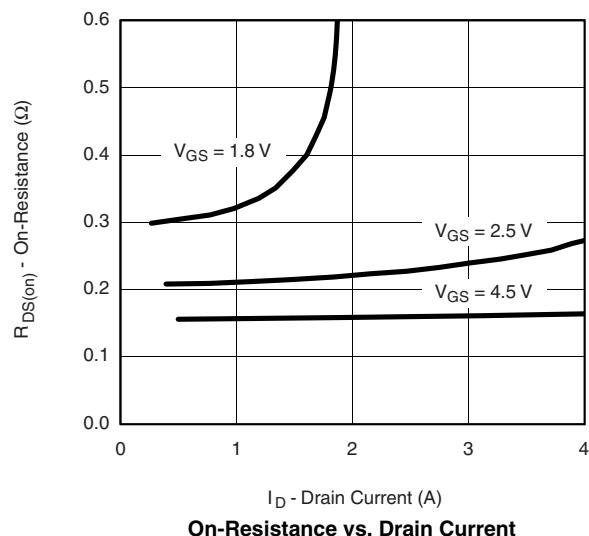
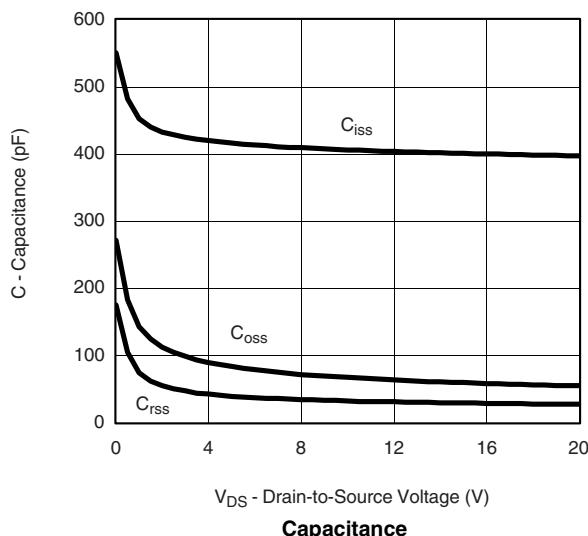
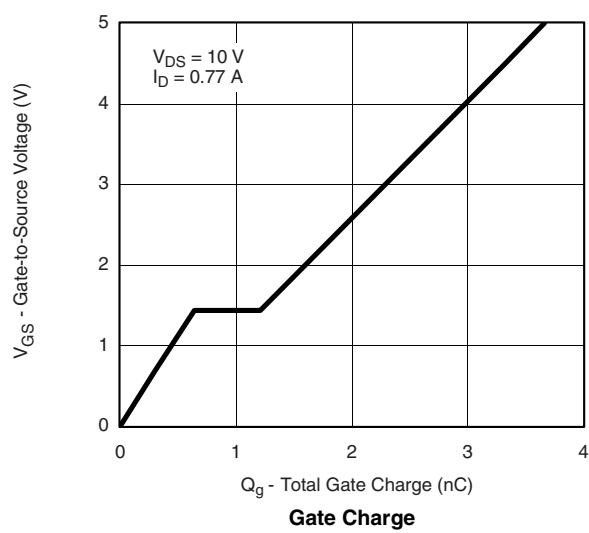
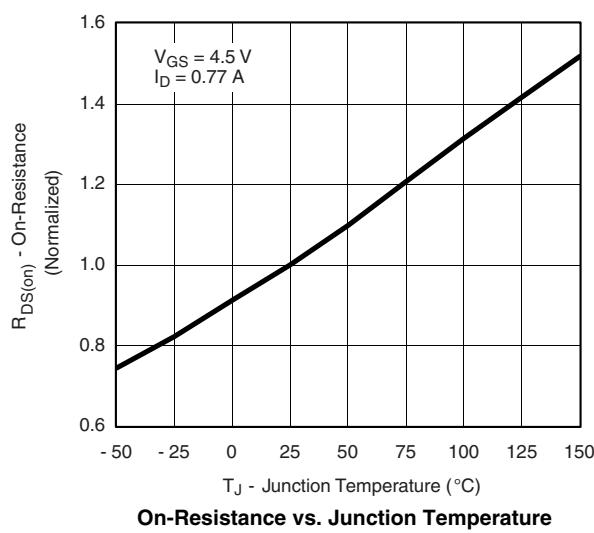
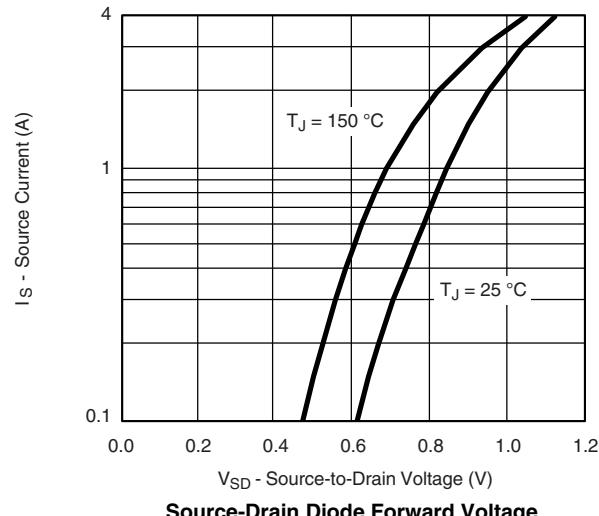
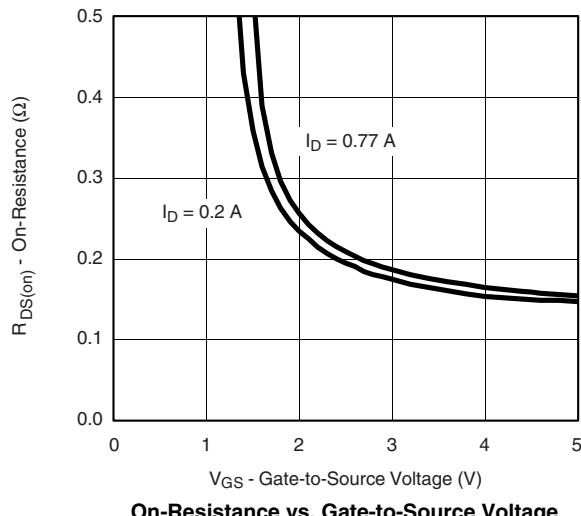
Notes:

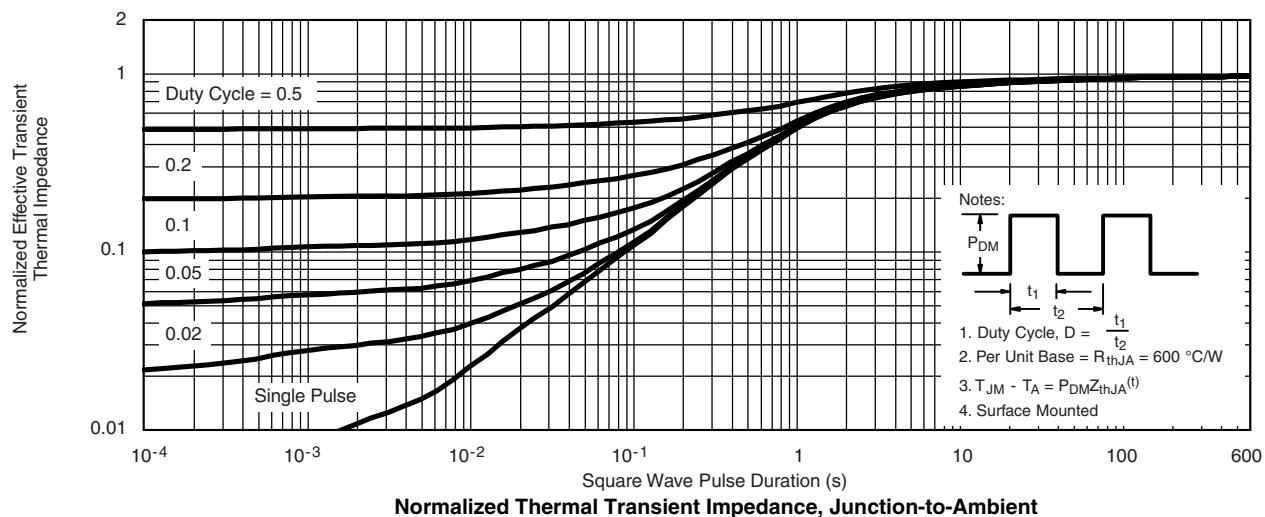
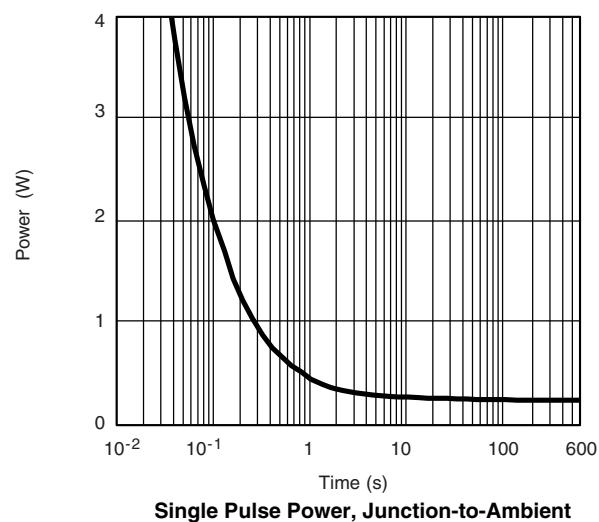
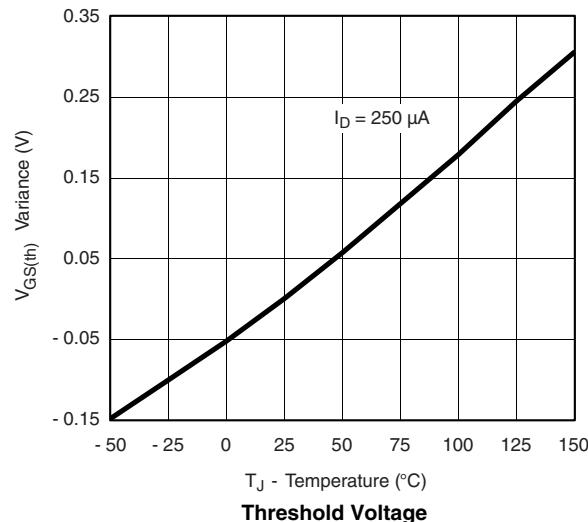
a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\ %$.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)


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On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)


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